## Declaration for U.S. Patent Application

RECEIVED

As a below named inventor, I hereby declare that:

JUL 1 7 2002

|   | miventor, I ner <del>osy</del> deen  |   |   |   | Tech  | nnology Center 2100   |  |
|---|--|---|---|---|---|---|--|
| My residence, post  | office address and citiz   | zenship are as sta  | ated belo   | ow next to my name.   | 1001  |   |  |
| names are listed be (Insert Title) IN   | low) of the subject mat FORMATION SERV   | ter which is clair  | med and   | e is listed below) or an ori<br>for which a patent is sou<br>RMATION SERVICE                                  | ght on the inver  | ntion entitled  |  |
|   | STEM COMPONEN  |   | 1   |   |   |   |  |
| the specification of  | which is attached here   | to unless the foll  | lowing is   | s спеске <b>а</b>   |   |   |  |
|   | vas filed on May 17, 2001 as United States Application Number or PCT International Application Number PCT/JP01/04099 and was amended on (if applicable). |   |   |   |   |   |  |
|   | have reviewed and und nendment referred to ab  |   | tents of t  | he above-identified speci   | fication, includ  | ing the claim(s), as  |  |
| I acknowledge the § 1.56.   | duty to disclose informa   | ation which is m  | aterial to  | patentability as defined  | in Title 37, Cod  | de of Federal Regulations,  |  |
| inventor's certificat   |  | also identified l   | below an  | es Code, § 119 (a) - (d) of<br>ny foreign application for<br>ed:  |   |   |  |
|   |  |   |   |   | Priority Clai   |   |  |
| (List prior   | 2000-145297  | Japan   |   | 17/05/2000  | <u>XX_</u> Yes  | No  |  |
| foreign applications.   | (Number)   | (Country)   | (Da   | ny/Month/Year Filed)  | Yes   | No  |  |
| See note A on back of this  | (Number)   | (Country)   |   | ny/Month/Year Filed)  |   | RECEIVED  |  |
| page)   | (Number)   | (Country)   | (Day/Month/Year Filed)                                |   | Yes   | JECE ONS  |  |
|   | (Number)   | (Country)   | (Day/Month/Year Filed)                                |   |   | HE 19 2002  |  |
| (See note B on back   | k of this page)  | See attac   | hed list f  | for additional prior foreig   | n applications  | CBOUP 36  |  |
| I hereby claim the besubject matter of eathe first paragraph of as defined in Title 3 the national or PCT | penefit under Title 35, United of the claims of this of Title 35, United States 37, Code of Federal Regulational filing data                             | United States Con<br>application is no<br>s Code, § 112, I a<br>gulations, § 1.56<br>te of this applica | de, § 120<br>ot disclo<br>cknowle<br>which b<br>tion. | O of any United States apposed in the prior United States in the duty to disclose in secame available between | olication(s) liste<br>ates application<br>formation whic<br>the filing date | ed be Grand, insofar as the in the manner provided by this material to patentability of the prior application and |  |
| (List Prior U.S.  |  |   |   |   |   |   |  |
| Applications)   | (Appln. Serial No  | o.) (Filing l   | Date)   | (Status: Patented, Pen  | ding, Abandon   | ed)   |  |
|   | (Appln. Serial No  | o.) (Filing   | Date)   | (Status: Patented, Pen  | ding, Abandone  | ed)   |  |
|   | (Appln. Serial No  | o.) (Filing l   | Date)   | (Status: Patented, Pen  | ding, Abandone  | ed)   |  |
|   |  |   |   |   |   |   |  |

RECEIVED
JUL 1 8 2002
GROUP 3600

I hereby appoint the following attorney, and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:



Please direct all communications to the following address:



PATENT TRADEMARK OFFICE

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

| (See note C            | Full name of sole or first inventor (given name, family name)Shogo ISHIOKA                 |                    |  |  |  |  |  |
|------------------------|--|--------------------|--|--|--|--|--|
| above)                 | Inventor's signature NHCGO ISHIOKA   | Date Jan, 8, 2002  |  |  |  |  |  |
|                        | Residence Fukayasu-gun, Japan  | Citizenship Japan  |  |  |  |  |  |
|                        | Post Office Address 827-3, Oaza-kawaminami, Kannabe-cho, Fukayasu-gun, Hiroshima 720-2124, |                    |  |  |  |  |  |
|                        | _ Japan  |                    |  |  |  |  |  |
|                        |  |                    |  |  |  |  |  |
| Full name of second    | inventor (given name, family name) Yuji  | ODAN               |  |  |  |  |  |
| Inventor's signature _ | Min Odu  | Date Jan. 20. 2002 |  |  |  |  |  |
| Residence              | Tosu-shi, Japan  | Citizenship Japan  |  |  |  |  |  |
|                        |  |                    |  |  |  |  |  |
| Post Office Address    | 807-2-3-203 Syukumachi Tosu-shi Saga 84  | 1.0052 Janan       |  |  |  |  |  |

Rev. 11/00